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SMD Photovoltaic Solar Cell Protection Schottky Rectifier



ĸ	<u> </u>	Anode 1
Cathode	Lo	Anode 2

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS			
I _{F(AV)}	12 A		
V _{RRM}	40 V		
I _{FSM}	280 A		
E _{AS}	20 mJ		
V_F at I_F = 12 A	0.43 V		
T _J max.	150 °C		
Package	SMPC (TO-277A)		
Circuit configuration	Single		

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- · Guardring for overvoltage protection
- Low forward voltage drop, low power losses
- High efficiency
- · Low thermal resistance
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in solar cell junction box as a bypass diode for protection, using DC forward current without reverse bias.

MECHANICAL DATA

Case: SMPC (TO-277A) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102 M3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	SS12P4S	UNIT	
Device marking code		124S		
Maximum repetitive peak reverse voltage	V _{RRM}	40	V	
Maximum DC forward current (fig. 1)	١ _F	12 ⁽¹⁾ 4.4 ⁽²⁾	А	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	280	А	
Non-repetitive avalanche energy at I_{AS} = 2.0 A, T_J = 25 °C	E _{AS}	20	mJ	
Operating junction and storage temperature range	T _{OP} , T _{STG}	-55 to +150	°C	
Junction temperature in DC forward current without reverse bias, t \leq 1 h $^{(3)}$	TJ	≤ 200	°C	

Notes

 $^{(1)}$ Mounted on 30 mm x 30 mm Al PCB with 50 mm x 25 mm x 100 mm fin heat sink

⁽²⁾ Free air, mounted on recommended copper pad area

⁽³⁾ Meets the requirements of IEC 61215 Ed. 2 bypass diode thermal test

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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CO	NDITIONS	SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 6 A$	T 25 °C	V _F ⁽¹⁾	0.43	-	V
	I _F = 12 A			0.50	0.60	
	I _F = 6 A	- T _A = 125 °C		0.33	-	
	I _F = 12 A			0.43	0.52	
Reverse current	V _R = 40 V	$T_{A} = 25 °C$ $T_{A} = 125 °C$	I _R ⁽²⁾	100	800	μA
	$v_{\rm R} = 40 v$		IR (=/	50	100	mA
Typical junction capacitance	4.0 V, 1 MHz		CJ	750	-	pF

Notes

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⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	VALUE	UNIT		
Typical thermal resistance	R _{θJA} ⁽¹⁾	100	°C/W		
	R _{0JM} ⁽²⁾	3	- C/W		

Notes

 $^{(1)}$ Free air, mounted on recommended copper pad area. Thermal resistance $R_{\theta JA}$ - junction to ambient.

 $^{(2)}$ Mounted on 30 mm x 30 mm AI PCB with 50 mm x 25 mm x 100 mm fin heat sink. Thermal resistance $R_{\theta JM}$ - junction to mount.

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SS12P4S-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel	
SS12P4S-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel	



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

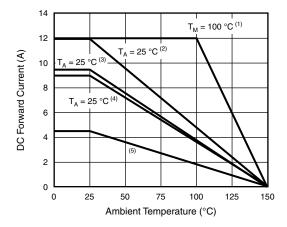


Fig. 1 - Maximum Current Derating Curve

Notes

 $^{(1)}$ Mounted on 30 mm x 30 mm Al PCB with 50 mm x 25 mm x 100 mm fin heat sink, $T_{\rm M}$ measured at the terminal of cathode band

- $^{(2)}$ Mounted on 30 mm x 30 mm Al PCB (R_{\theta JA} = 20 °C/W)
- $^{(3)}$ Mounted on 30 mm x 30 mm x 2 copper pad areas FR4 PCB (R_{θ JA} = 30 °C/W)
- ⁽⁴⁾ Mounted on 25 mm x 25 mm x 2 copper pad areas FR4 PCB ($R_{\theta,JA} = 30 \text{ °C/W}$)
- $^{(5)}$ Free air, mounted on recommended copper pad area (R_{θ JA} = 100 °C/W)

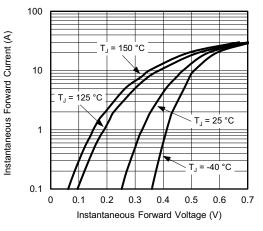


Fig. 3 - Typical Instantaneous Forward Characteristics

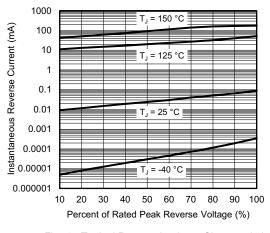


Fig. 4 - Typical Reverse Leakage Characteristics

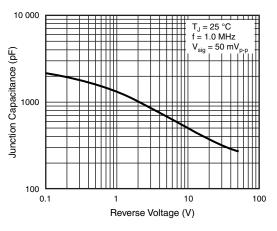


Fig. 5 - Typical Junction Capacitance

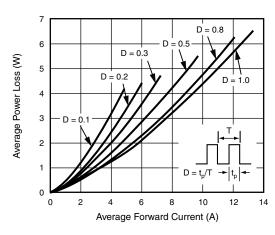


Fig. 2 - Forward Power Loss Characteristics

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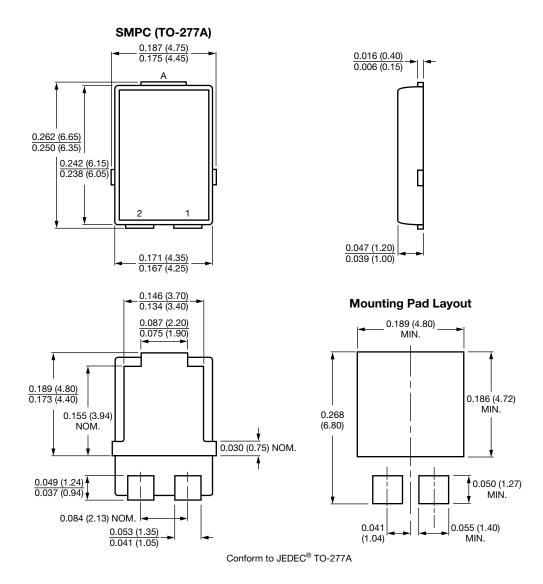
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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